

#### Features

- Guard Ring Die Construction for Transient Protection
- Low Leakage Current
- Low Forward Voltage Drop
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SOD123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish Annealed over Alloy 42
  Leadframe. Solderable per MIL-STD-202, Method 208 3
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)

SOD123



Top View

#### Ordering Information (Note 4)

Part Number	Case	Packaging
B140HW-7	SOD123	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

4. For packaging details, go to our website at http://www.diodes.com.

### **Marking Information**

SOD123



LO = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code K	Key												
Year	2005	2006	2007	2008	2009	2010	2011	201	2 201	3 201	4 2015	2016	2017
Code	S	Т	U	V	W	Х	Y	Z	A	В	С	D	E
Month	Jan	Feb	Mar	Apr	Ма	iy J	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8	9	0	Ν	D



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Forward Current (See Figure 1)	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	IFSM	16	A
Repetitive Peak Reverse Current $t_p = 2\mu square wave, f = 1KHz$	I <sub>RRM</sub>	0.5	A
Non-Repetitive Peak Reverse Current tp = 100µs square wave	I <sub>RSM</sub>	1.0	A

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Typical Power Dissipation	(Note 5) (Note 6)	PD	350 410	mW
Typical Thermal Resistance Junction to Ambient	(Note 5) (Note 6)	$R_{ extsf{ heta}JA}$	304 251	°C/W
Operating and Storage Temperature Range		TJ, T <sub>STG</sub>	-65 to +125	°C

### Electrical Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	40		_	V	$I_R = 40 \mu A$
Forward Voltage	VF		0.52 0.48	0.55 0.51	V	I <sub>F</sub> = 1A, T <sub>J</sub> = +25 ℃ I <sub>F</sub> = 1A, T <sub>J</sub> = +100 ℃
Leakage Current (Note 7)	I <sub>R</sub>		 0.2	10 40 5	μA μA mA	V <sub>R</sub> = 5V, T <sub>J</sub> = +25 ℃ V <sub>R</sub> = 40V, T <sub>J</sub> = +25 ℃ V <sub>R</sub> = 40V, T <sub>A</sub> = +100 ℃

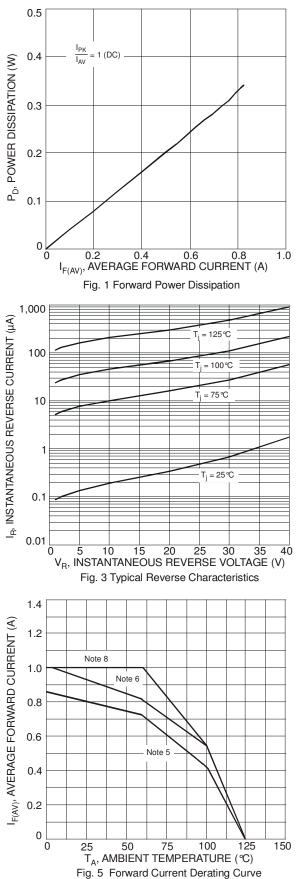
Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

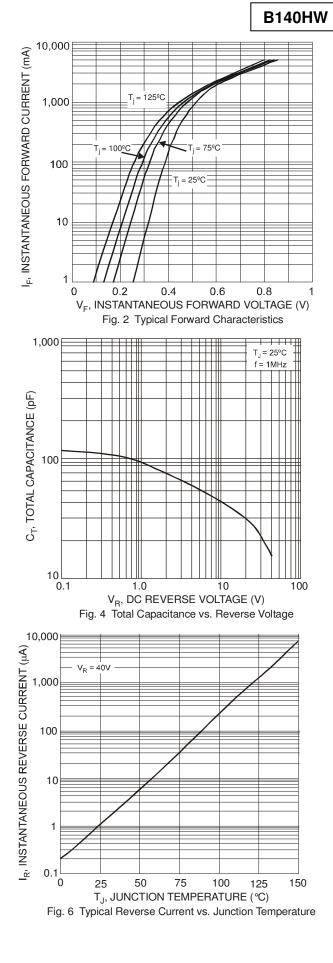
6. Part mounted on 1 inch sq. 2oz copper pad.

7. Short duration pulse test used to minimize self-heating effect.

8. Part mounting such that  $R_{\theta JA}$  = 175 °C/W.



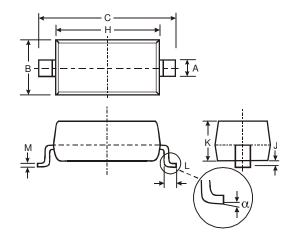






# **Package Outline Dimensions**

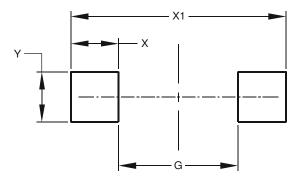
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD123							
Dim	Min Max						
Α	0.55 Typ						
В	1.40	1.70					
С	3.55	3.85					
H	2.55 2.85						
J	0.00 0.10						
K	1.00 1.35						
L	0.25	0.40					
М	0.10	0.15					
α	0	8°					
All Di	All Dimensions in mm						

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	2.250
Х	0.900
X1	4.050
Y	0.950



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